

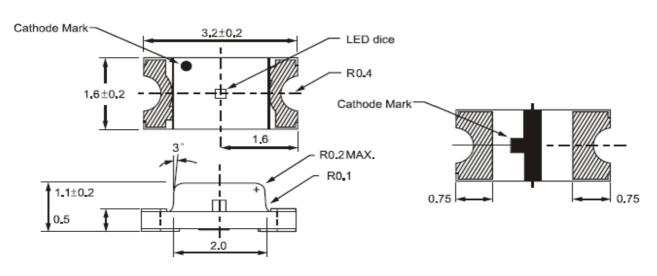


Applications

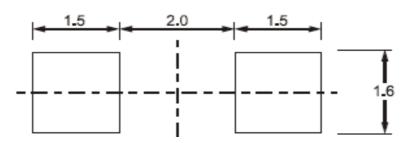
Interior automotive lighting

 Optical indicators
 Communication Products
 Backlighting
 Toys

Technical Drawing



Recommended Soldering Pattern



Part No.: M11F	[:] 6016
Customer:	
DRW: Dong CHKD Chang MATL: Chui DATE	05.12.2009
APPD: Ping FINISH Hui Sheet	1 from 9

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Absolute Maximum Ratings

Ta=25°C

Item	Symbol	AllnGaN	Unit
Power Dissipation	PD		mW
DC Forward Current	I _F	30	mA
Plused Forward Current	I _{FP} *	100	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{OP}	-25 to 80	°C
Storage Temperature	T _{ST}	-30 to 85	°C

* 0.1 msec pulse, 10% duty cycle

Electrcal / Optical Characteristics

I_F=20mA Ta=25°C

Ermitting Color		Blue						
Material		AllnGaN						
Forward Voltage	typ.	2.8	V _F					
r orward voltage	max.	3.2	V _F					
Wavelength	λD	465 ~ 470	nm					
	λP	460	nm					
typ.	Δλ		nm					
Color Temperature	min.		K					
Color remperature	max.		K					
Luminous Intensity *	min.	8.2	mcd					
Lummous intensity	typ.	15	mcd					
Reverse Current	max.		μA					
Viewing Angle	2Θ1/2	120						

* Per NIST standards

						SMT Chip LED Blue)
					Part No.: M11F6016		F6016
					Custome	er:	
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Directive Characteristics

					SMT Chip LED Blue		
					Part No.: M11F6016		F6016
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Curvs

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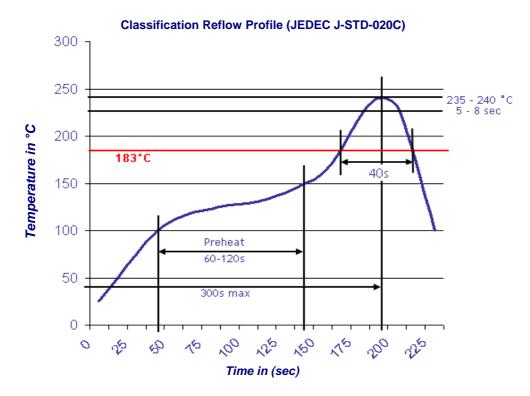
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Solder Condition

Lead Free Solder



			,	SMT Chip LEL Blue	0
			Part No.: M11F6016		
			Custome	er:	
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Dong

Ping

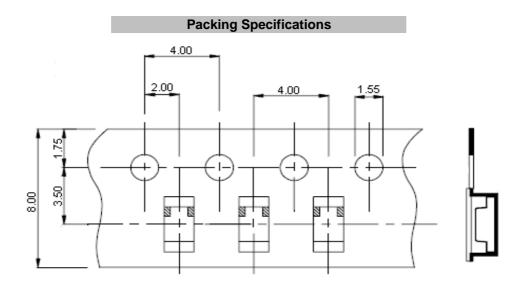
DRW:

APPD:

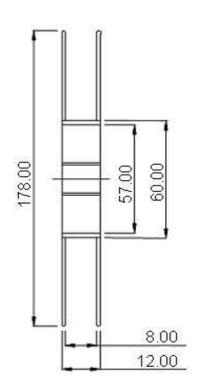
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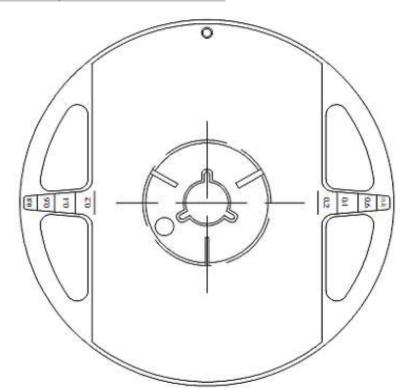






Reel Specifications





					SMT Chip LED Blue		
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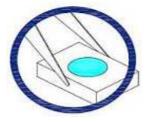




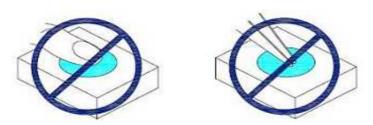
Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



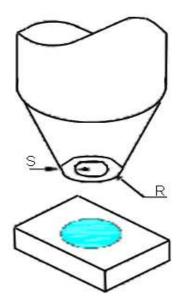
						SMT Chip LEI Blue)
					Part No.	No.: M11F6016	
					Custome	er:	
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- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



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Dong

Ping

CHKD

DRW:

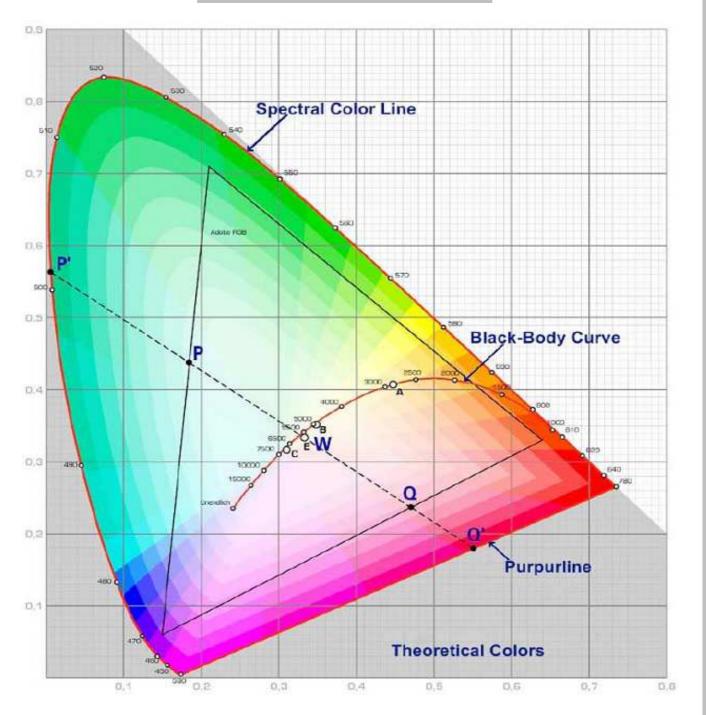
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Color table curve



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